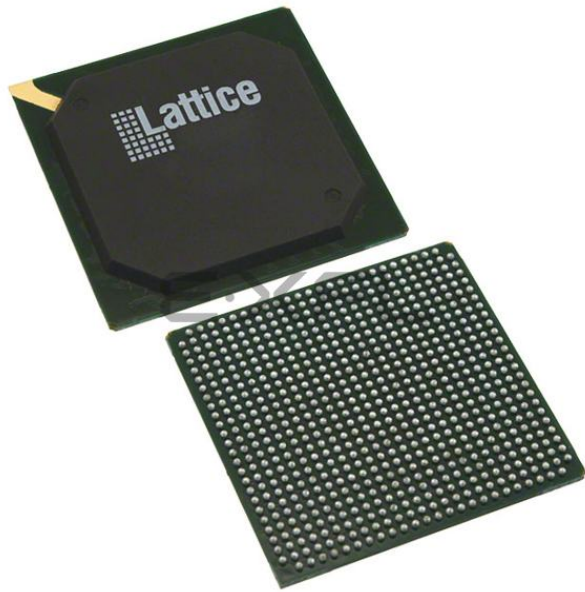




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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	5.2 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	32
Number of Macrocells	1024
Number of Gates	-
Number of I/O	381
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc51024mv-52f672c

Figure 3. MFB in SuperWIDE Logic Mode†

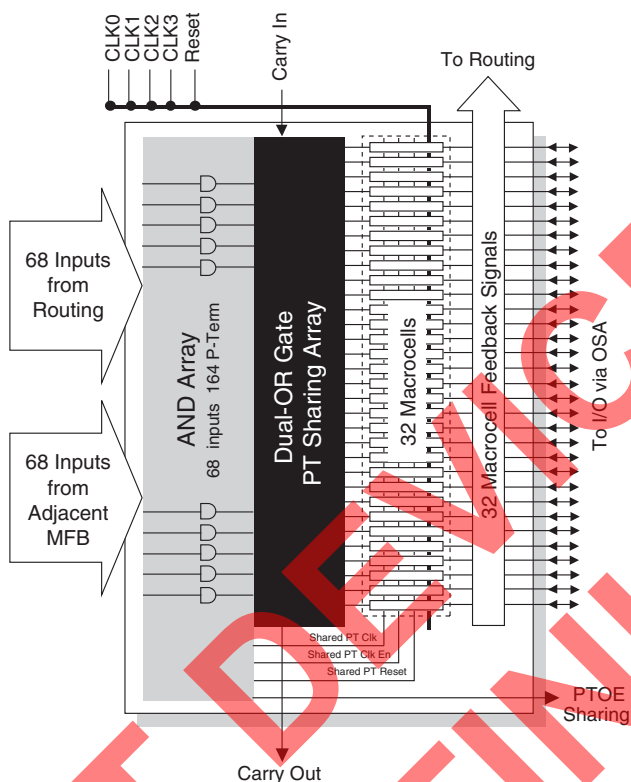


Figure 4. Macrocell Slice in Logic Mode AND-Array

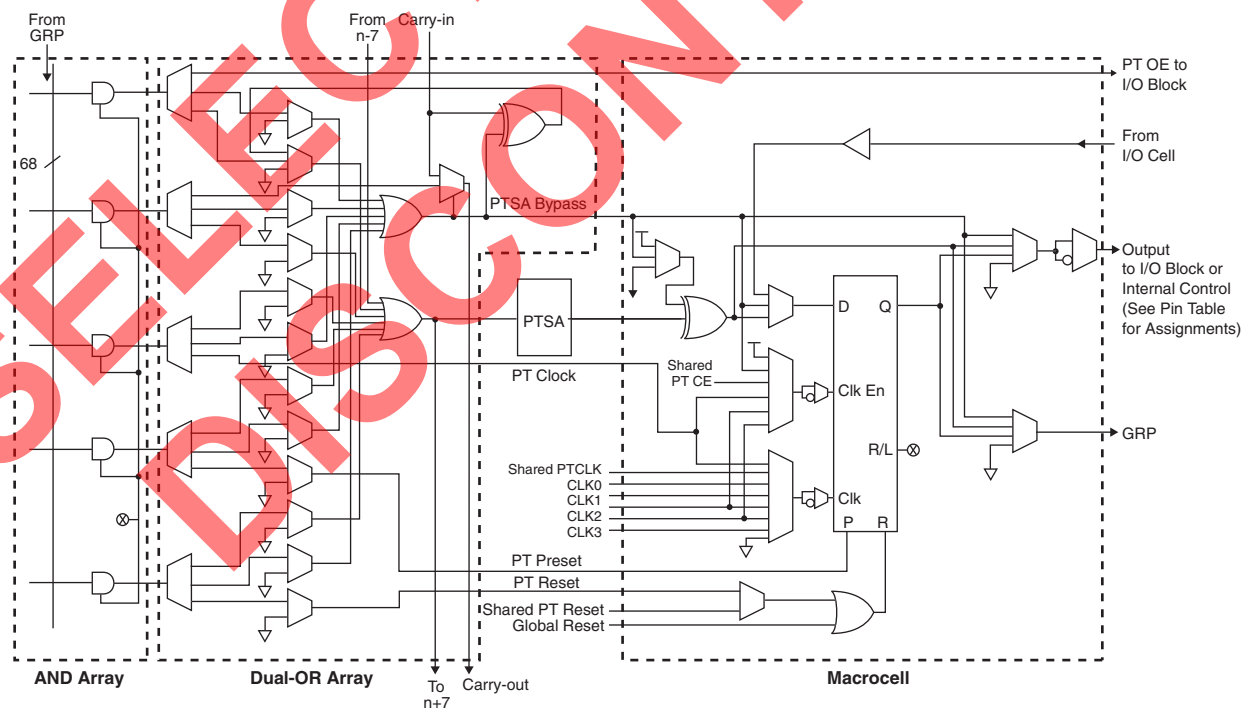
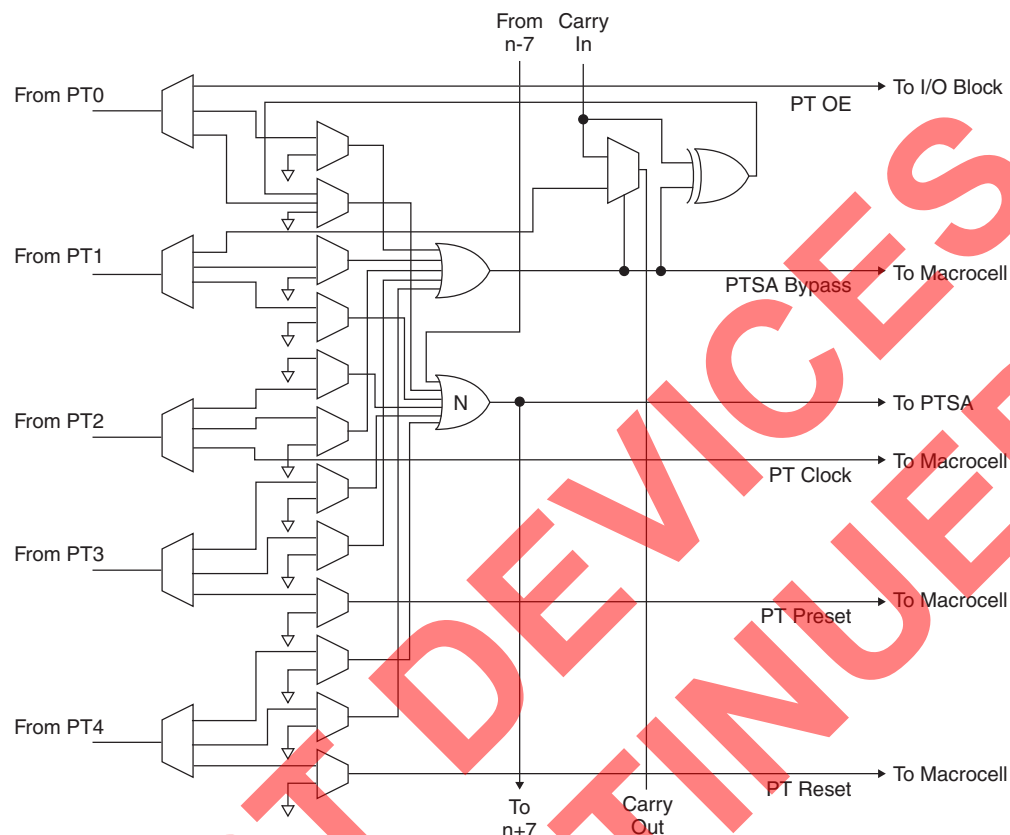
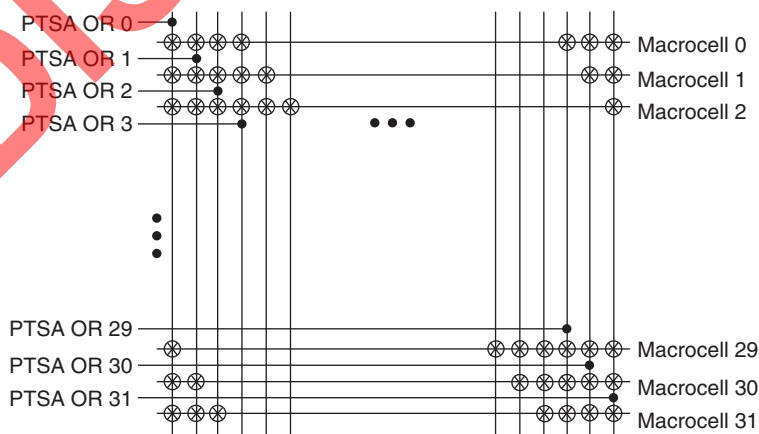


Figure 6. Dual-OR PT Sharing Array

Product Term Sharing Array

The Product Term Sharing Array (PTSA) consists of 32 inputs from the Dual-OR Array (Expandable PTSA OR) and 32 outputs directly to the macrocells. Each output is the OR term of any combination of the seven Expandable PTSA OR terms connected to that output. Every Nth macrocell is connected to N-3, N-2, N-1, N, N+1, N+2 and N+3 PTSA OR terms via a programmable connection. This wraps around the logic, for example, Macrocell 0 gets its logic from 29, 30, 31, 0, 1, 2, 3. The Expandable PTSA OR used in conjunction with the PTSA allows wide functions to be implemented easily and efficiently. Without using the Expandable PTSA OR capability, the greatest number of product terms that can be included in a single function with one pass of delay is 35. Up to 160 product terms can be included in a single function through the use of the expandable PTSA OR capability. Figure 7 shows the graphical representation of the PTSA.

Figure 7. Product Term Sharing Array (PTSA)

Pseudo Dual-Port SRAM Mode

In Pseudo Dual-Port SRAM Mode the multi-function array is configured as a SRAM with an independent read and write ports that access the same 16,384-bits of memory. Data widths of 1, 2, 4, 8, 16 and 32 are supported by the MFB. Figure 10 shows the block diagram of the Pseudo Dual-Port SRAM.

Write data, write address, chip select and write enable signals are always synchronous (registered). The read data and read address signals can be synchronous or asynchronous. Reset is asynchronous. All write signals share the same clock, and clock enable. All read signals share the same clock and clock enable. Reset is shared by both read and write signals. Table 6 shows the possible sources for the clock, clock enable and initialization signals for the various registers.

Figure 10. Pseudo Dual-Port SRAM Block Diagram

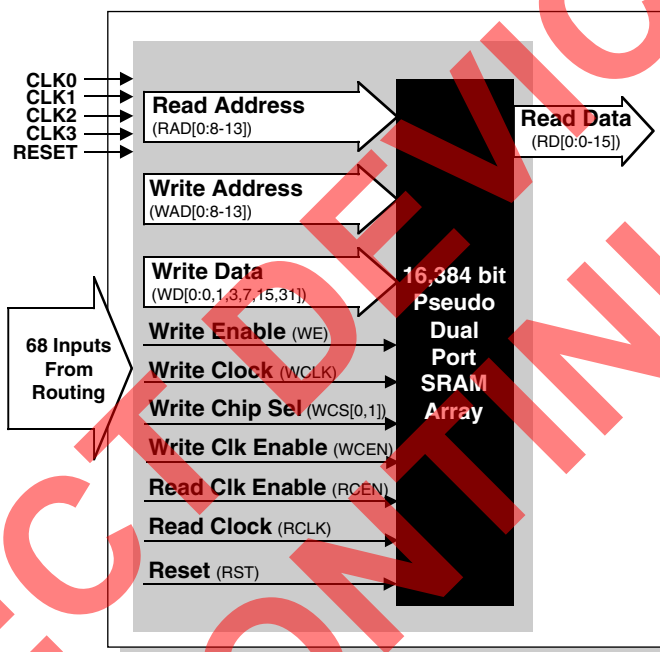


Table 6. Register Clock, Clock Enable, and Reset in Pseudo Dual-Port SRAM Mode

Register	Input	Source
Write Address, Write Data, Write Enable, and Write Chip Select	Clock	WCLK or one of the global clocks (CLK0 - CLK3). The selected signal can be inverted if desired.
	Clock Enable	WCEN or one of the global clocks (CLK1 - CLK2). The selected signal can be inverted if desired.
	Reset	Created by the logical OR of the global reset signal and RST. RST may have inversion if desired.
Read Data and Read Address	Clock	RCLK or one of the global clocks (CLK0 - CLK3). The selected signal can be inverted if desired.
	Clock Enable	RCEN or one of the global clocks (CLK1 - CLK2). The selected signal can be inverted if desired.
	Reset	Created by the logical OR of the global reset signal and RST. RST may have inversion if desired.

FIFO Mode

In FIFO Mode the multi-function array is configured as a FIFO (First In First Out) buffer with built in control. The read and write clocks can be different or the same dependent on the application. Four flags show the status of the FIFO; Full, Empty, Almost Full, and Almost Empty. The thresholds for Full, Almost full and Almost empty are programmable by the user. It is possible to reset the read pointer, allowing support of frame retransmit in communications applications. If desired, the block can be used in show ahead mode allowing the early reading of the next read address.

In this mode one ports accesses 16,384-bits of memory. Data widths of 1, 2, 4, 8, 16 and 32 are supported by the MFB. Figure 12 shows the block diagram of the FIFO.

Write data, write enable, flag outputs and read enable are synchronous. The Write Data, Almost Full and Full share the same clock and clock enables. Read outputs are synchronous although these can be configured in look ahead mode. The Read Data, Empty and Almost Empty signals share the same clock and clock enables. Reset is shared by all signals. Table 8 shows the possible sources for the clock, clock enable and reset signals for the various registers.

Figure 12. FIFO Block Diagram

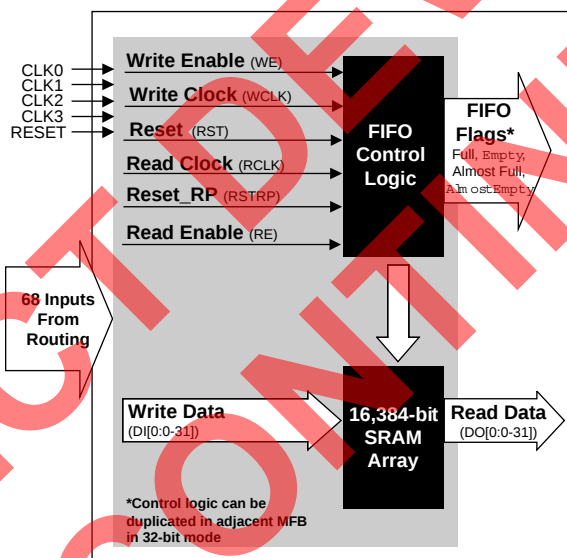


Table 8. Register Clocks, Clock Enables, and Initialization in FIFO Mode

Register	Input	Source
Write Data, Write Enable	Clock	WCLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	WE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	N/A
Full and Almost Full Flags	Clock	WCLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	WE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired.
Read Data, Empty and Almost Empty Flags	Clock	RCLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	RE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired.

CAM Mode

In CAM Mode the multi-function array is configured as a Ternary Content Addressable Memory (CAM). CAM behaves like a reverse memory where the input is data and the output is an address. It can be used to perform a variety of high-performance look-up functions. As such, CAM has two modes of operation. In write or update mode the CAM behaves as a RAM and data is written to the supplied address. In read or compare operations data is supplied to the CAM and if this matches any of the data in the array the Match and Multiple Match (if there is more than one match) flags are set to true and the lowest address with matching data is output. The CAM contains 128 entries of 48 bits. Figure 13 shows the block diagram of the CAM.

To further enhance the flexibility of the CAM a mask register is available. If enabled during updates, bits corresponding with those set to 1 in the mask register are not updated. If enabled during compare operations, bits corresponding to those set to 1 in the mask register are not included in the compare. A write don't care signal allows don't cares to be programmed into the CAM if desired. Like other write operations the mask register controls this.

The write/comp data, write address, write enable, write chip select, and write don't care signals are synchronous. The CAM Output signals, match flag, and multimatch flag can be synchronous or asynchronous. The Enable mask register input is not latched but must meet setup and hold times relative to the write clock. All inputs must use the same clock and clock enable signals. All outputs must use the same clock and clock enable signals. Reset is common for both inputs and outputs. Table 9 shows the allowable sources for clock, clock enable, and reset for the various CAM registers.

Figure 13. CAM Mode

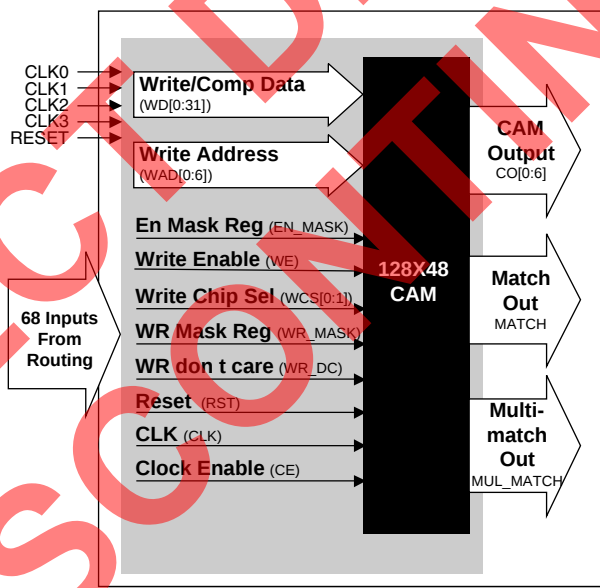
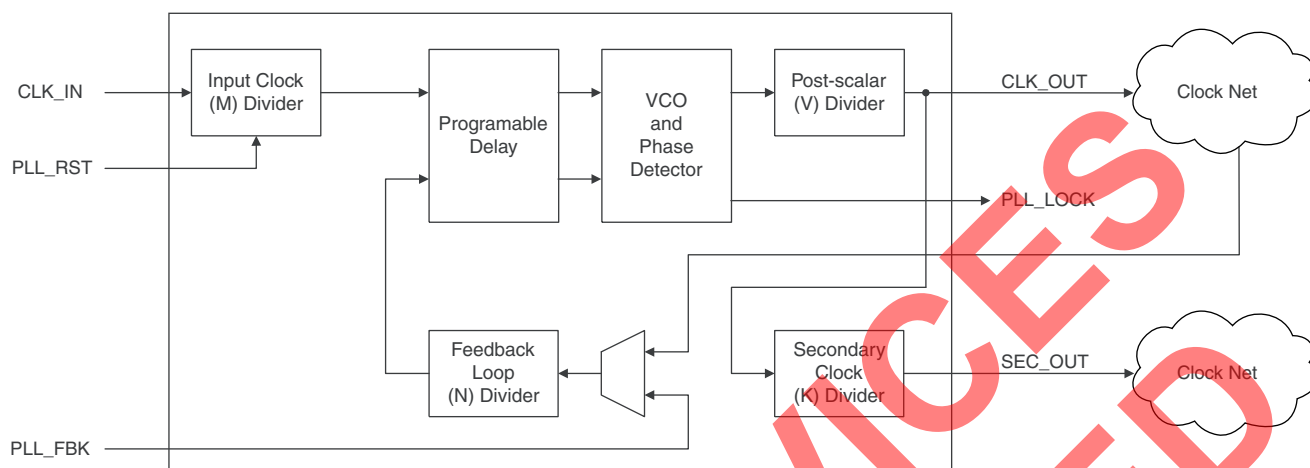
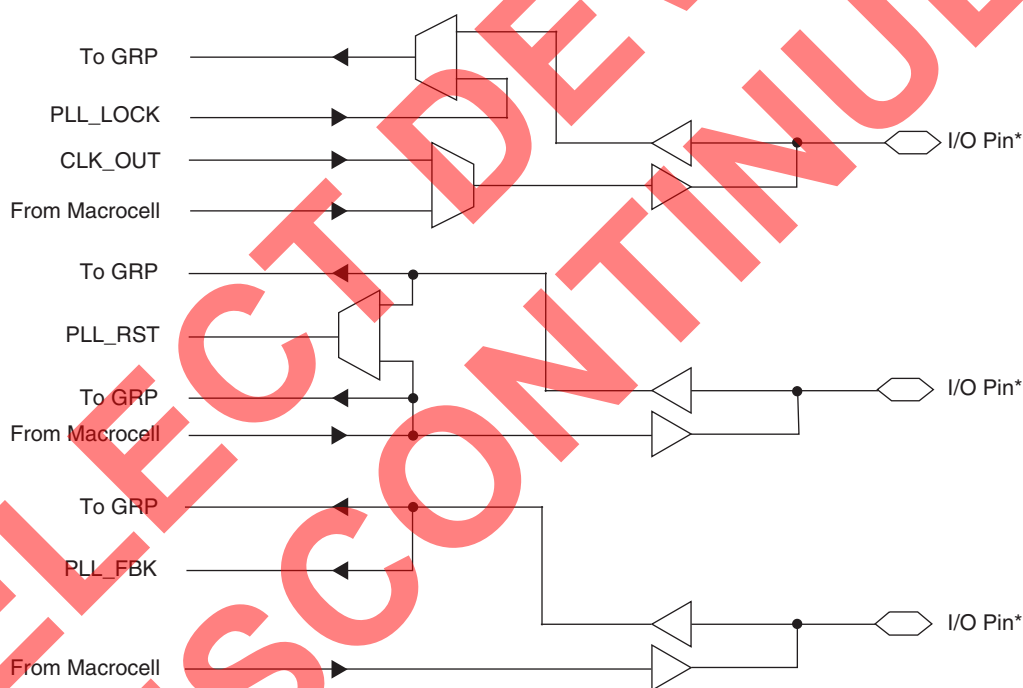


Table 9. Register Clocks, Clock Enables, and Initialization in CAM Mode

Register	Input	Source
Write data, Write address, Enable mask register, Write enable, write chip select, and write don't care, CAM Output, Match, and Multimatch	Clock	CLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	WE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired

Figure 15. PLL Block Diagram**Figure 16. Connection of Optional PLL Inputs and Outputs**

*See pinout table for details

In order to facilitate the multiply and divide capabilities of the PLL, each PLL has dividers associated with it: M, N and K. The M divider is used to divide the clock signal, while the N divider is used to multiply the clock signal. The K divider is only used when a secondary clock output is needed. This divider divides the primary clock output and feeds to a separate global clock net. The V divider is used to provide lower frequency output clocks, while maintaining a stable, high frequency output from the PLL's VCO circuit. The PLL also has a delay feature that allows the output clock to be advanced or delayed to improve set-up and clock-to-out times for better performance. For more information on the PLL, please refer to TN1003, [sysCLOCK PLL Usage Guide for ispXPGA, ispGDX2, ispXPLD and ispMACH 5000VG Devices](#).

Figure 17. I/O Cell



Table 10. Shared PTOE Segments

Device	MFBs Associated With Segments
ispXPLD 5256MX	(A, B, C, D) (E, F, G, H)
ispXPLD 5512MX	(A, B, C, D) (E, F, G, H) (I, J, K, L) (M, N, O, P)
ispXPLD 5768MX	(A, B, C, D) (E, F, G, H) (I, J, K, L) (M, N, O, P) (Q, R, S, T) (U, V, W, Z)
ispXPLD 51024MX	(A, B, C, D) (E, F, G, H) (I, J, K, L) (M, N, O, P) (Q, R, S, T) (U, V, W, Z) (Y, Z, AA, AB) (AC, AD, AE, AF)

sysIO Standards

Each I/O within a bank is individually configurable based on the V_{CCO} and V_{REF} settings. Some standards also require the use of an external termination voltage. Table 12 lists the sysIO standards with the typical values for V_{CCO} , V_{REF} and V_{TT} . For more information on the sysIO capability, refer to TN1000, [sysIO Usage Guidelines for Lattice Devices](#).

Table 11. Number of I/Os per Bank

Device	Maximum Number of I/Os per Bank (n)
ispXPLD 5256MX	36
ispXPLD 5512MX	68
ispXPLD 5768MX	96
ispXPLD 51024MX	96

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{PDPRWH}	R/W Hold time after Clock Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{PDPDATAS}	Data Setup before Clock Time	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{PDPDATAH}	Data Hold time after Clock Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{PDPRLKO}	Read Clock to Output Delay	—	—	5.08	—	5.02	—	5.66	—	5.45	—	8.54	ns
t _{PDPCLKSKEW}	Opposite Clock Cycle Delay	—	1.40	—	1.40	—	1.76	—	1.76	—	1.83	—	ns
t _{P DPRSTO}	Reset to RAM Output Delay	—	—	3.30	—	3.30	—	4.13	—	4.13	—	4.29	ns
t _{P DPRSTR}	Reset Recovery Time	—	1.20	—	1.20	—	1.50	—	1.50	—	1.56	—	ns
t _{P DPRSTPW}	Reset Pulse Width	—	0.14	—	0.14	—	0.18	—	0.18	—	0.19	—	ns
Dual Port RAM													
t _{DPMSAS}	Memory Select A Setup Before R/W A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t _{DPMSAH}	Memory Select Hold time after R/W A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{DPCEAS}	Clock Enable A Setup before Clock A Time	—	3.72	—	3.72	—	3.72	—	3.72	—	4.84	—	ns
t _{DPCEAH}	Clock Enable A Hold time after Clock A Time	—	-2.95	—	-2.95	—	-2.95	—	-2.95	—	-2.27	—	ns
t _{DPADDAS}	Address A Setup before Clock A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t _{DPADDAH}	Address A Hold time after Clock A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{DPRWAS}	R/W A Setup before Clock A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t _{DPRWAH}	R/W A Hold time after Clock A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{DPDATAAS}	Write Data A Setup before Clock A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t _{DPDATAAH}	Write Data A Hold time after Clock A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{DPMSBS}	Memory Select B Setup Before R/W B Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t _{DPMSBH}	Memory Select Hold time after R/W B Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns

ispXPLD 5000MX Family Timing Adders (Continued)

Parameter	Description	Base Param.	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
HSTL_I_out	Using HSTL 2.5V, Class I	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_III_out	Using HSTL 2.5V, Class III	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
HSTL_IV_out	Using HSTL 2.5V, Class IV	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVDS_out	Using Low Voltage Differential Signaling (LVDS)	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.8	—	0.8	—	0.8	—	0.8	—	0.8	ns
LVPECL_out	Using Low Voltage PECL	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
PCI_out	Using PCI Standard	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
SSTL2_I_out	Using SSTL 2.5V, Class I	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
SSTL2_II_out	Using SSTL 2.5V, Class II	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_out	Using SSTL 3.3V, Class I	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.2	—	0.2	—	0.2	—	0.2	—	0.2	ns
SSTL3_II_out	Using SSTL 3.3V, Class II	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns

Timing v.1.8

ispXP sysCONFIG Port Timing Specifications

Symbol	Timing Parameter	Min.	Max.	Units
sysCONFIG Write Cycle Timing				
t_{SUCS}	Input setup time of CS to CCLK rise	10	—	ns
t_{HCS}	Hold time of CS to CCLK rise	1	—	ns
t_{SUWD}	Input setup time of write data to CCLK rise	10	—	ns
t_{HWD}	Hold time of write data to CCLK rise	0	—	ns
t_{PRGM}	Low time to reset device SRAM	5	50	ns
t_{DINIT}	INIT delay time	—	5	ms
t_{IODISS}	User I/O disable	—	—	ns
t_{IOENSS}	User I/O enable	—	—	ns
t_{WH}	Write clock High pulse width	18	—	ns
t_{WL}	Write clock Low pulse width	18	—	ns
f_{MAXW}	Write f_{MAX}	—	27	MHz
sysCONFIG Read Cycle Timing				
t_{HREAD}	Hold time of READ to CCLK rise	1	—	ns
t_{SUREAD}	Input setup time of READ High to CCLK rise	15	—	ns
t_{RH}	READ clock high pulse width	18	—	ns
t_{RL}	READ clock low pulse width	18	—	ns
f_{MAXR}	Read f_{MAX}	—	27	MHz
t_{CORD}	Clock to out for read data	—	25	ns

Switching Test Conditions

Figure 21 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 14.

Figure 21. Output Test Load, LVTTTL and LVCMOS Standards



Table 14. Test Fixture Required Components

Test Condition	R ₁	R ₂	C _L	Timing Ref.	V _{CCO}
Default LVCMOS 1.8 I/O (L → H, H → L)	106	106	35pF	V _{CCO} /2	1.8V
LVCMOS I/O (L → H, H → L)	—	—	35pF	LVCMOS3.3 = 1.5V	LVCMOS3.3 = 3.0V
				LVCMOS2.5 = V _{CCO} /2	LVCMOS2.5 = 2.3V
				LVCMOS1.8 = V _{CCO} /2	LVCMOS1.8 = 1.65V
Default LVCMOS 1.8 I/O (Z → H)	—	106	35pF	V _{CCO} /2	1.65V
Default LVCMOS 1.8 I/O (Z → L)	106	—	35pF	V _{CCO} /2	1.65V
Default LVCMOS 1.8 I/O (H → Z)	—	106	5pF	V _{OH} - 0.15	1.65V
Default LVCMOS 1.8 I/O (L → Z)	106	—	5pF	V _{OL} + 0.15	1.65V

Note: Output test conditions for all other interfaces are determined by the respective standards.

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
—	GCLK0N	GCLK1	—	—	—	28	J2	P7
—	—	GND	—	—	—	29	GND	GND
—	—	TDI	—	—	—	30	H6	R1
—	—	TMS	—	—	—	31	H4	R2
—	—	TCK	—	—	—	32	J6	T1
—	—	TDO	—	—	—	33	K2	V1
1	0P	A0/DATA0	B0	D0	A1	34	K3	W1
1	0N	A2/DATA1	B1	D1	A3	35	J3	Y1
1	1P	A4/DATA2	B2	D2	A5	36	J5	P3
1	1N	A6/DATA3	B3	D3	A7	37	J4	R3
1	2P	A8/DATA4	B4	D4	A9	38	L2	T2
1	2N	A10/DATA5	B5	D5	A11	39	M1	U2
—	—	GND (Bank 1)	—	—	—	40	GND (Bank 1)	GND (Bank 1)
1	3P	A12/DATA6	B6	D6	A13	41	K4	V2
—	—	V _{CCO1}	—	—	—	42	V _{CCO1}	V _{CCO1}
1	3N	A14/DATA7	B7	D7	A15	43	L3	W2
—	—	GND	—	—	—	44	GND	GND
1	4P	A16/INITB	B8	D8	A17	45	K5	R4
1	4N	A18/CSB	B9	D9	A19	46	L5	T4
1	5P	A20/READ	B10	D10	A21	47	N1	R6
1	5N	A22/CCLK	B11	D11	A23	48	M2	R5
1	6P	A24	—	—	A25	—	—	U3
—	—	VCC	—	—	—	49	VCC	VCC
1	6N	A26	—	—	A27	—	P1 ¹	V3
1	7P	A28	—	—	A29	—	M3	Y2
1	7N	A30	—	—	A31	—	L4	W3
1	8P	B0	A0	—	B1	—	N2	U5
1	8N	B2	A2	—	B3	—	P2	T5
—	—	GND (Bank 1)	—	—	—	—	GND (Bank 1)	GND (Bank 1)
1	9P	B4	A4	—	—	—	R1	U4
—	—	V _{CCO1}	—	—	—	—	V _{CCO1}	V _{CCO1}
1	9N	B5	A6	—	—	—	R2	V4
1	10P	B6	A8	—	B7	—	T2	AA3
1	10N	B8	A10	—	B9	—	T3	AB3
1	—	B10	A12	—	B11	—	—	Y4
—	—	DONE	—	—	—	50	M4	AA4
1	11P	B14	B12	D12	B15	51	N3	AB4
1	11N	B16	B13	D13	B17	52	P4	AB5
1	12P	B18	B14	D14	B19	53	N5	T6
1	12N	B20	B15	D15	B21	54	M6	U7
—	—	PROGRAMB	—	—	—	55	R3	W5
1	—	B22	A14	—	B23	—	P5	U8
—	—	GND (Bank 1)	—	—	—	56	GND (Bank 1)	GND (Bank 1)

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
3	61N	I14	I23	K23	I15	149	G13	D22
3	61P	I12	I22	K22	I13	150	G12	D21
3	62N	I10	I21	K21	I11	151	F14	J20
3	62P	I8/CLK_OUT1	I20	K20	I9	152	E15	J19
3	63N	I6	K31	—	I7	—	F12	E20
—	—	V _{CC}	—	—	—	153	V _{CC}	V _{CC}
3	63P	I4	K30	L30	I5	—	F13	F20
3	64N	I2	K29	L28	I3	—	D16	H17
3	64P	I0	K28	L26	I1	—	D15	H18
—	—	GND (Bank 3)	—	—	—	—	GND (Bank 3)	GND (Bank 3)
3	65N	J30	K27	—	J31	—	—	J18
—	—	V _{CCO3}	—	—	—	—	V _{CCO3}	V _{CCO3}
3	65P	J28	K26	—	J29	—	—	H19
3	66N	J26	K25	—	J27	—	—	G20
3	66P	J24	K24	—	J25	—	—	G19
3	67N	J22	K23	—	J23	—	—	C22
3	67P	J20	K22	—	J21	—	—	C21
3	68N	J18	K21	—	J19	—	—	D20
3	68P	J16	K20	—	J17	—	—	C19
3	69N	J14	K19	—	J15	—	C16	F19
3	69P	J12	K18	—	J13	—	B16	E19
—	—	GND (Bank 3)	—	—	—	—	GND (Bank 3)	GND (Bank 3)
3	70N	J10	K17	—	J11	—	C15	G18
—	—	V _{CCO3}	—	—	—	—	V _{CCO3}	V _{CCO3}
3	70P	J8	K16	—	J9	—	B15	F18
3	71N	J6	K15	—	J7	—	E14	B20
3	71P	J4	K14	—	J5	—	D14	B19
3	72N	J2	K13	—	J3	—	E13	A20
3	72P	J0	K12	—	J1	—	A15	A19
3	73N	K30	I19	K19	K31	154	D12	D18
3	73P	K28	I18	K18	K29	155	B14	C18
3	74N	K26	I17	K17	K27	156	C13	G17
3	74P	K24	I16	K16	K25	157	A14	F16
3	75N	K22	I31	K31	K23	158	A13	E17
3	75P	K21	I30	K30	—	159	B13	D17
—	—	GND (Bank 3)	—	—	—	160	GND (Bank 3)	GND (Bank 3)
3	76N	K20	K11	L21	—	—	D11	B18
—	—	V _{CCO3}	—	—	—	161	V _{CCO3}	V _{CCO3}
3	76P	K18	K10	L20	K19	—	B12	A18
3	77N	K16	K9	L18	K17	—	C12	C17
3	77P	K14	K8	L16	K15	—	E11	B17
3	78N	K12	K7	L12	K13	—	—	C16
3	78P	K10	K6	L10	K11	—	—	B16

ispXPLD 5768MX Logic Signal Connections

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	127N	S22	S11	T18	S23	C4	B4
0	127P	S20	S10	T16	S21	E4	A4
0	128N	S18	Q17	S17	S19	B1	B3
0	128P	S16	Q16	S16	S17	C1	A3
0	129N	S14	Q15	S15	S15	D3	F5
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	129P	S12	Q14	S14	S13	C2	G6
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	130N	S10	Q13	S13	S11	E3	H6
0	130P	S8	Q12	S12	S9	D2	G5
0	131N	S6	S9	T14	S7	—	D3
0	131P	S4	S8	T12	S5	—	D2
0	132N	S2	S7	T10	S3	—	E4
-	-	VCC	-	-	-	VCC	VCC
0	132P	S0	S6	T8	S1	—	E3
-	-	GND	-	-	-	GND	GND
0	133N	T30	S5	T6	T31	—	F4
0	133P	T28	S4	T4	T29	—	G4
0	134N	T26	S3	T2	T27	—	C2
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	134P	T24	S2	T0	T25	—	C1
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	135N	T22	S1	-	T23	D1	F3
0	135P	T20	S0	-	T21	E1	G3
0	136N	T18	S31	-	T19	F4	H4
-	-	VCC	-	-	-	VCC	VCC
0	136P	T16	S30	-	T17	F5	J4
0	137N	T14	Q11	S11	T15	E2	H5
0	137P	T12/CLK_OUT0	Q10	S10	T13	F2	J5
0	138N	T10	Q9	S9	T11	F1	E2
0	138P	T8	Q8	S8	T9	G1	F2
-	-	GND	-	-	-	GND	GND
0	139N	T6	Q7	S7	T7	F3	D1
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	139P	T4	Q6	S6	T5	G5	E1
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	140N	T2	Q5	S5	T3	H5	J3
0	140P	T0/PLL_RST0	Q4	S4	T1	G4	H2
0	141N	U30	U31	W31	U31	G3	G2
0	141P	U28/PLL_FBK0	U30	W30	U29	H3	G1
0	142N	U26	U29	W29	U27	—	J6
0	142P	U24	U28	W28	U25	—	K4

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
1	-	C28	D14	-	C29	P5	U8
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	15P	C26	D16	-	C27	T4	V6
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	15N	C24	D18	-	C25	T5	V7
-	-	GND	-	-	-	GND	GND
1	16P	C22	D20	-	C23	R4	Y5
-	-	VCC	-	-	-	VCC	VCC
1	16N	C20	D22	-	C21	N6	AA5
1	17P	C18	-	-	C19	R5	Y6
1	17N	C16	-	-	C17	P6	Y7
1	18P	C14	-	-	C15	-	AA6
1	18N	C12	-	-	C13	-	AA7
1	19P	C10	-	-	C11	-	W7
1	19N	C8	-	-	C9	M7	V8
1	20P	C6	-	-	C7	T6	W8
1	20N	C4	-	-	C5	R6	U9
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
-	-	CFG0	-	-	-	L8	U10
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	21P	C0	C16	A16	C1	T7	AB7
1	21N	D30	C17	A17	D31	R7	AA8
1	22P	D28	C18	A18	D29	N7	AB8
1	22N	D26	C19	A19	D27	P7	AB9
1	23P	D24	C20	A20	D25	T8	W9
1	23N	D22	C21	A21	D23	R8	Y9
1	24P	D20	C22	A22	D21	M8	AB10
1	24N	D18	C23	A23	D19	P8	AA10
1	-	D16/VREF1	-	-	D17	L9	W10
1	25P	D14	C24	A24	D15	N8	Y10
1	25N	D12	C25	A25	D13	M9	Y11
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	26P	D10	C26	A26	D11	N10	V9
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	26N	D8	C27	A27	D9	T9	V10
1	27P	D6	C28	A28	D7	T10	AA11
-	-	GND	-	-	-	GND	GND
1	27N	D4	C29	A29	D5	R9	AB11
-	-	VCC	-	-	-	VCC	VCC
1	28P	D2	C30	A30	D3	P9	U11
1	28N	D0	C31	A31	D1	N9	V11
2	29P	E0	F0	H0	E1	T11	AB12
-	-	VCC	-	-	-	VCC	VCC

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	31P	G26	H16	-	G27	V6	AB7
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	31N	G24	H18	-	G25	V7	AC7
-	-	GND	-	-	-	GND	GND
1	32P	G22	H20	-	G23	Y5	AB6
-	-	VCC	-	-	-	VCC	VCC
1	32N	G20	H22	-	G21	AA5	AC6
1	33P	G18	-	-	G19	Y6	AC8
1	33N	G16	-	-	G17	Y7	AC9
1	34P	G14	-	-	G15	AA6	AC5
1	34N	G12	-	-	G13	AA7	AD4
1	35P	G10	-	-	G11	W7	AD5
1	35N	G8	-	-	G9	V8	AD6
1	36P	G6	-	-	G7	W8	AD7
1	36N	G4	-	-	G5	U9	AD8
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
-	-	CFG0	-	-	-	U10	AE3
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	37P	G0	G16	E16	G1	AB7	AD9
1	37N	H30	G17	E17	H31	AA8	AD10
1	38P	H28	G18	E18	H29	AB8	AE4
1	38N	H26	G19	E19	H27	AB9	AE5
1	39P	H24	G20	E20	H25	W9	AE6
1	39N	H22	G21	E21	H23	Y9	AE7
1	40P	H20	G22	E22	H21	AB10	AE8
1	40N	H18	G23	E23	H19	AA10	AE9
1	-	H16/VREF1	-	-	H17	W10	AE10
1	41P	H14	G24	E24	H15	Y10	AF3
1	41N	H12	G25	E25	H13	Y11	AF4
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	42P	H10	G26	E26	H11	V9	AF5
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	42N	H8	G27	E27	H9	V10	AF6
1	43P	H6	G28	E28	H7	AA11	AF7
-	-	GND	-	-	-	GND	GND
1	43N	H4	G29	E29	H5	AB11	AF8
-	-	VCC	-	-	-	VCC	VCC
1	44P	H2	G30	E30	H3	U11	AF9
1	44N	H0	G31	E31	H1	V11	AF10
2	45P	I0	J0	L0	I1	AB12	AF17
-	-	VCC	-	-	-	VCC	VCC
2	45N	I2	J1	L1	I3	AA12	AF18

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	GCLK3P	GCLK3	-	-	-	N16	N24
3	93N	R0	T31	R31	R1	J22	N23
3	93P	R2	T30	R30	R3	H22	N22
3	94N	R4	T29	R29	R5	N19	M26
3	94P	R6	T28	R28	R7	P15	M25
3	95N	R8	T27	R27	R9	P21	M23
3	95P	R10	T26	R26	R11	N15	M22
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	96N	R12	T25	R25	R13	M15	N20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	96P	R14	T24	R24	R15	N20	M20
-	-	GND	-	-	-	GND	GND
3	97N	R16	T23	R23	R17	P22	N21
3	97P	R18	T22	R22	R19	N21	M21
3	98N	R20	T21	R21	R21	N17	M24
3	98P	R22	T20	R20	R23	M20	L24
3	99N	R24	T19	R19	R25	P17	L23
-	-	VCC	-	-	-	VCC	VCC
3	99P	R26	T18	R18	R27	P18	L22
3	100N	R28	T17	R17	R29	M21	L25
3	100P	R30	T16	R16	R31	M17	K26
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	101N	T0	T15	R15	T1	L20	K25
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	101P	T2	T14	R14	T3	N18	K24
3	102N	T4	T13	R13	T5	L21	K23
3	102P	T6	T12	R12	T7	M18	K22
3	103N	T8	T11	R11	T9	L22	J25
3	103P	T10	T10	R10	T11	L17	J24
3	104N	T12	T9	R9	T13	K22	L21
3	104P	T14	T8	R8	T15	L18	K21
3	105N	T16	T7	R7	T17	K21	L20
3	105P	T18	T6	R6	T19	K18	K20
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	106N	T20	T5	R5	T21	K20	J23
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	106P	T22	T4	R4	T23	K17	J22
3	107N	T24	T3	R3	T25	K19	J26
3	107P	T26	T2	R2	T27	J17	H26
3	108N	T28	T1	R1	T29	E22	H25
3	108P	T30/PLL_FBK1	T0	R0	T31	E21	H24
3	109N	U0/PLL_RST1	X27	V27	U1	G22	H23
3	109P	U2	X26	V26	U3	F21	H22

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	142N	Y26	Y29	AA29	Y27	B11	A10
0	142P	Y24	Y28	AA28	Y25	A11	A9
0	143N	Y22	Y27	AA27	Y23	F11	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	143P	Y20	Y26	AA26	Y21	F10	A7
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	144N	Y18	Y25	AA25	Y19	E10	A6
0	144P	Y16	Y24	AA24	Y17	C10	A5
0	145N	Y14/VREF0	Y3	AA3	Y15	D10	A4
0	145P	Y12	Y2	AA2	Y13	B10	A3
0	146N	Y10	Y23	AA23	Y11	A10	B10
0	146P	Y8	Y22	AA22	Y9	A9	B9
0	147N	Y6	Y21	AA21	Y7	C9	B8
0	147P	Y4	Y20	AA20	Y5	D9	B7
0	148N	Y2	Y19	AA19	Y3	F9	B6
0	148P	Y0	Y18	AA18	Y1	E9	B5
0	149N	Z30	Y1	AA1	Z31	A8	B4
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	149P	Z28	Y0	AA0	Z29	B8	B3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	150N	Z26	AA29	-	Z27	A7	C10
0	150P	Z24	AA28	-	Z25	B7	C9
0	151N	Z22	AA27	-	Z23	A5	C8
0	151P	Z20	AA26	-	Z21	B5	C7
0	152N	Z18	AA25	-	Z19	B6	C6
0	152P	Z16	AA24	-	Z17	C7	C5
0	153N	Z14	AA23	-	Z15	E8	C4
0	153P	Z12	AA22	-	Z13	E7	D5
0	154N	Z10	AA21	-	Z11	E6	D9
-	-	VCC	-	-	-	VCC	VCC
0	154P	Z8	AA20	-	Z9	D6	D8
-	-	GND	-	-	-	GND	GND
0	155N	Z6	AA19	-	Z7	D8	D7
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	155P	Z4	AA18	-	Z5	F8	D6
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	156N	Z2	AA17	-	Z3	F7	F9
0	156P	Z0	AA16	-	Z1	D7	E9
0	157N	AA30	AA15	-	AA31	C6	F7
0	157P	AA28	AA14	-	AA29	C5	F8
0	158N	AA26	AA13	-	AA27	C4	G8
0	158P	AA24	AA12	-	AA25	D5	G9

Global Clock LVDS pair options: GCLK0 and GCLK1, as well as GCLK2 and GCLK3, can be paired together to receive differential clocks; where GCLK0 and GCLK3 are the positive LVDS inputs.

SELECT DEVICES
DISCONTINUED

Lead-Free Packaging

ispXPLD 5000MC (1.8V) Lead-Free Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-4FN256C	256	1.8	4.0	Lead-free fpBGA	256	141	C
	LC5256MC-5FN256C	256	1.8	5.0	Lead-free fpBGA	256	141	C
	LC5256MC-75FN256C	256	1.8	7.5	Lead-free fpBGA	256	141	C
LC5512MC	LC5512MC-45QN208C	512	1.8	4.5	Lead-free PQFP	208	149	C
	LC5512MC-75QN208C	512	1.8	7.5	Lead-free PQFP	208	149	C
	LC5512MC-45FN256C	512	1.8	4.5	Lead-free fpBGA	256	193	C
	LC5512MC-75FN256C	512	1.8	7.5	Lead-free fpBGA	256	193	C
	LC5512MC-45FN484C	512	1.8	4.5	Lead-free fpBGA	484	253	C
	LC5512MC-75FN484C	512	1.8	7.5	Lead-free fpBGA	484	253	C
LC5768MC	LC5768MC-5FN256C	768	1.8	5.0	Lead-free fpBGA	256	193	C
	LC5768MC-75FN256C	768	1.8	7.5	Lead-free fpBGA	256	193	C
	LC5768MC-5FN484C	768	1.8	5.0	Lead-free fpBGA	484	317	C
	LC5768MC-75FN484C	768	1.8	7.5	Lead-free fpBGA	484	317	C
LC51024MC	LC51024MC-52FN484C	1024	1.8	5.2	Lead-free fpBGA	484	317	C
	LC51024MC-75FN484C	1024	1.8	7.5	Lead-free fpBGA	484	317	C
	LC51024MC-52FN672C	1024	1.8	5.2	Lead-free fpBGA	672	381	C
	LC51024MC-75FN672C	1024	1.8	7.5	Lead-free fpBGA	672	381	C

ispXPLD 5000MC (1.8V) Lead-Free Industrial Devices

Device	Part Number	Macrocells	Voltage (V)	t _{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-5FN256I	256	1.8	5.0	Lead-free fpBGA	256	141	I
	LC5256MC-75FN256I	256	1.8	7.5	Lead-free fpBGA	256	141	I
LC5512MC	LC5512MC-75QN208I	512	1.8	7.5	Lead-free PQFP	208	149	I
	LC5512MC-75FN256I	512	1.8	7.5	Lead-free fpBGA	256	193	I
	LC5512MC-75FN484I	512	1.8	7.5	Lead-free fpBGA	484	253	I
LC5768MC	LC5768MC-75FN256I	768	1.8	7.5	Lead-free fpBGA	256	193	I
	LC5768MC-75FN484I	768	1.8	7.5	Lead-free fpBGA	484	317	I
LC51024MC	LC51024MC-75FN484I	1024	1.8	7.5	Lead-free fpBGA	484	317	I
	LC51024MC-75FN672I	1024	1.8	7.5	Lead-free fpBGA	672	381	I